

EXHIBIT D

From: "Sheppard, Robert F" <sheppard@hp.com>
To: <Chad.Terrell@bakerbotts.com>
CC: <"Mehta, Boney">
Date: 1/21/2004 3:09 AM
Subject: RE: CLAM Patent Application (EDS 70-03-002; 014208.1635)

Chad,

These have been despatched today as requested.

Kind regards,

Robert F. Sheppard
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-----Original Message-----

From: Chad.Terrell@bakerbotts.com [mailto:Chad.Terrell@bakerbotts.com]
Sent: 20 January 2004 01:04
To: robert.sheppard@eds.com
Subject: CLAM Patent Application (EDS 70-03-002; 014208.1635)

Robert,

Would you please send me an email confirming that you sent three original signed copies of the formal papers for the CLAM patent application by mail (or FedEx) yesterday, January 19, 2004? If so, I will go ahead and file the patent application with the U.S. Patent Office.

If you have any questions, please let me know.

Thanks,

Chad

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